



CD40174 Hex D-type flip-flop

Product Specification

Specification Revision History:

Version	Date	Description
2023-04-A1	2023-04	New



1、General Description

The CD40174 is a hex edge-triggered D-type flip-flop.

Features:

- Supply voltage range:3V to 15V
- Temperature range:-40℃ to +125℃
- Packaging information: DIP16/SOP16/TSSOP16

Ordering Information:

Tube packing specifications:

Part number	Packaging form	Marking code	Tube quantity	Boxed tube quantity	Boxed quantity	Notes
CD40174DA16.TB	DIP16	CD40174	25 PCS/tube	40 tube/box	1000 PCS/box	Dimensions of plastic enclosure: 19.0mm×6.4mm Pin spacing:2.54mm
CD40174SA16.TB	SOP16	CD40174	50 PCS/tube	200 tube/box	10000 PCS/box	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing:1.27mm
CD40174TA16.TB	TSSOP16	CD40174	96 PCS/tube	200 tube/box	19200 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing:0.65mm

Reel packing specifications:

Part number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Notes
CD40174SA16.TR	SOP16	CD40174	4000PCS/reel	8000PCS/box	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing:1.27mm
CD40174TA16.TR	TSSOP16	CD40174	5000PCS/reel	10000PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing:0.65mm

Note: If the physical information is inconsistent with the ordering information, please refer to the actual product.



2、Block Diagram And Pin Description

2.1、Block Diagram

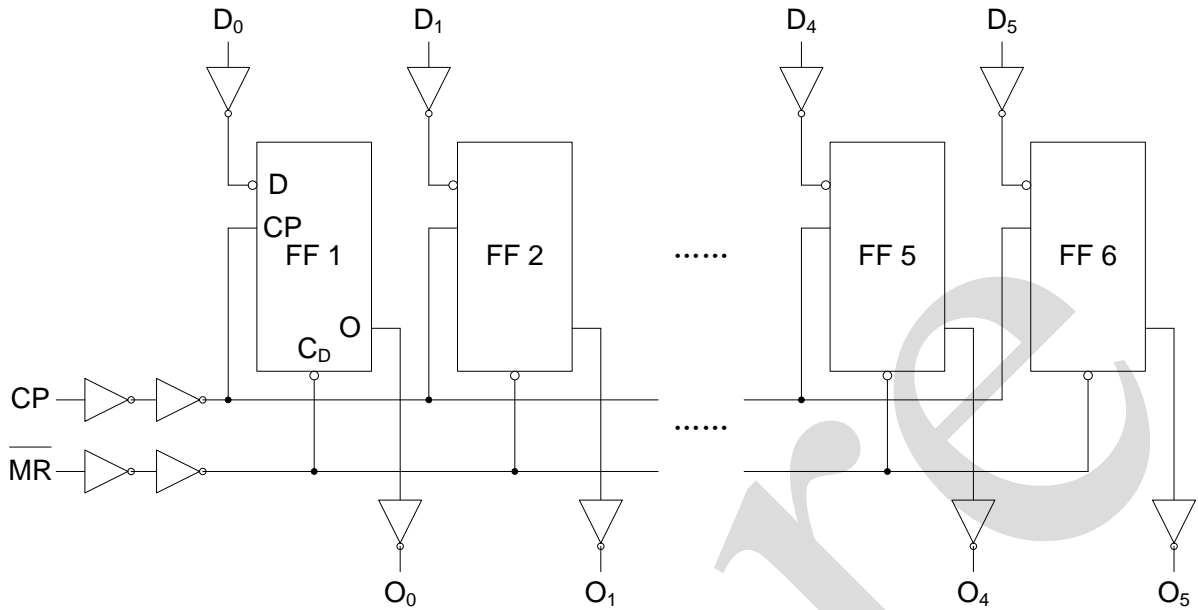


Figure 1. Functional diagram

2.2、Pin Configurations

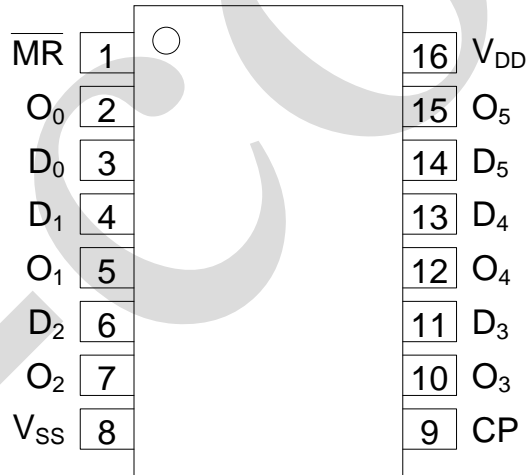


Figure 2. Pin configurations



2.3、Pin Description

Pin No.	Pin Name	Description
1	$\overline{\text{MR}}$	clock input
2	O_0	buffered output
3	D_0	data input
4	D_1	data input
5	O_1	buffered output
6	D_2	data input
7	O_2	buffered output
8	V_{SS}	ground supply voltage
9	CP	clock input
10	O_3	buffered output
11	D_3	data input
12	O_4	buffered output
13	D_4	data input
14	D_5	data input
15	O_5	buffered output
16	V_{DD}	supply voltage

2.4、Function Table

Input			Output
CP	D	$\overline{\text{MR}}$	O
↑	H	H	H
↑	L	H	L
↓	X	H	no change
X	X	L	L

Note: H=HIGH voltage level; L=LOW voltage level. X=state is immaterial.

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(Voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	V_{DD}	-	-0.5	+18	V
input voltage	V_{I}	all inputs	-0.5	$\text{V}_{\text{DD}}+0.5$	V
DC input current	I_{IK}	any one input	-	± 10	mA
storage temperature	T_{stg}	-	-65	+150	°C
soldering temperature	T_{L}	10s	DIP	245	°C
			SOP/TSSOP	260	



3.2、Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	V_{DD}	-	3	-	15	V
ambient temperature	T_{amb}	in free air	-40	-	+125	°C

3.3、Electrical Characteristics

3.3.1、DC Characteristics 1

($T_{amb}=-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	V_{DD}	Conditions	Min.	Typ.	Max.	Unit
HIGH-level input voltage	V_{IH}	5V	-	3.5	-	-	V
		10V	-	7	-	-	V
		15V	-	11	-	-	V
LOW-level input voltage	V_{IL}	5V	-	-	-	1.5	V
		10V	-	-	-	3	V
		15V	-	-	-	4	V
HIGH-level output voltage	V_{OH}	5V	$ I_O <1\mu\text{A}$	4.95	-	-	V
		10V	$ I_O <1\mu\text{A}$	9.95	-	-	V
		15V	$ I_O <1\mu\text{A}$	14.95	-	-	V
LOW-level output voltage	V_{OL}	5V	$ I_O <1\mu\text{A}$	-	-	0.05	V
		10V	$ I_O <1\mu\text{A}$	-	-	0.05	V
		15V	$ I_O <1\mu\text{A}$	-	-	0.05	V
HIGH-level output current	I_{OH}	5V	$V_O=4.6\text{V}$	-	-	-0.34	mA
		5V	$V_O=2.5\text{V}$	-	-	-1.3	mA
		10V	$V_O=9.5\text{V}$	-	-	-0.55	mA
		15V	$V_O=13.5\text{V}$	-	-	-1.65	mA
LOW-level output current	I_{OL}	5V	$V_O=0.4\text{V}$	0.34	-	-	mA
		10V	$V_O=0.5\text{V}$	0.46	-	-	mA
		15V	$V_O=1.5\text{V}$	1.4	-	-	mA
input leakage current	I_I	15V	$V_I=15\text{V}$ or GND	-	-	± 2	μA
supply current	I_{DD}	5V	$V_I=5\text{V}$ or GND; $I_O=0\text{A}$	-	-	7.5	μA
		10V	$V_I=10\text{V}$ or GND; $I_O=0\text{A}$	-	-	15	μA
		15V	$V_I=15\text{V}$ or GND; $I_O=0\text{A}$	-	-	30	μA



3.3.2、DC Characteristics 2

($T_{amb}=-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	V_{DD}	Conditions	Min.	Typ.	Max.	Unit
HIGH-level input voltage	V_{IH}	5V	-	3.5	-	-	V
		10V	-	7	-	-	V
		15V	-	11	-	-	V
LOW-level input voltage	V_{IL}	5V	-	-	-	1.5	V
		10V	-	-	-	3	V
		15V	-	-	-	4	V
HIGH-level output voltage	V_{OH}	5V	$ I_O <1\mu\text{A}$	4.95	-	-	V
		10V	$ I_O <1\mu\text{A}$	9.95	-	-	V
		15V	$ I_O <1\mu\text{A}$	14.95	-	-	V
LOW-level output voltage	V_{OL}	5V	$ I_O <1\mu\text{A}$	-	-	0.05	V
		10V	$ I_O <1\mu\text{A}$	-	-	0.05	V
		15V	$ I_O <1\mu\text{A}$	-	-	0.05	V
HIGH-level output current	I_{OH}	5V	$V_O=4.6\text{V}$	-	-	-0.3	mA
		5V	$V_O=2.5\text{V}$	-	-	-1.15	mA
		10V	$V_O=9.5\text{V}$	-	-	-0.45	mA
		15V	$V_O=13.5\text{V}$	-	-	-1.4	mA
LOW-level output current	I_{OL}	5V	$V_O=0.4\text{V}$	0.29	-	-	mA
		10V	$V_O=0.5\text{V}$	0.38	-	-	mA
		15V	$V_O=1.5\text{V}$	1.2	-	-	mA
input leakage current	I_I	15V	$V_I=15\text{V}$ or GND	-	-	± 4	μA
supply current	I_{DD}	5V	$V_I=5\text{V}$ or GND; $I_O=0\text{A}$	-	-	7.5	μA
		10V	$V_I=10\text{V}$ or GND; $I_O=0\text{A}$	-	-	15	μA
		15V	$V_I=15\text{V}$ or GND; $I_O=0\text{A}$	-	-	30	μA



3.3.3. AC Characteristics 1

($T_{amb}=-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, $V_{SS}=0\text{V}$, unless otherwise specified.)

Parameter	Symbol	V_{DD}	Conditions	Min.	Typ.	Max.	Unit
propagation delay time	t_{PHL}, t_{PLH}	5V	CP to Qn See Figure 4	-	75	155	ns
		10V		-	30	65	ns
		15V		-	20	45	ns
$\overline{\text{MR}}$ to Qn HIGH to LOW propagation delay time	t_{PHL}	5V	See Figure 5	-	85	175	ns
		10V		-	35	70	ns
		15V		-	25	50	ns
transition time	t_{THL}, t_{TLH}	5V	See Figure 4	-	60	120	ns
		10V		-	30	60	ns
		15V		-	20	40	ns
set-up time	t_{su}	5V		20	10	-	ns
		10V		10	5	-	ns
		15V		10	5	-	ns
hold time	t_{hold}	5V		10	0	-	ns
		10V		5	0	-	ns
		15V		5	0	-	ns
Minimum clock pulse width; LOW	t_{WCPL}	5V	See Figure 5	70	35	-	ns
		10V		30	15	-	ns
		15V		20	10	-	ns
Minimum $\overline{\text{MR}}$ pulse width; LOW	t_{WMRL}	5V		70	35	-	ns
		10V		35	15	-	ns
		15V		25	10	-	ns
Recovery time for $\overline{\text{MR}}$	t_{RMR}	5V		45	25	-	ns
		10V		20	10	-	ns
		15V		15	5	-	ns
Maximum clock pulse frequency	f_{max}	5V	-	5	11	-	MHZ
		10V	-	15	30	-	MHZ
		15V	-	20	45	-	MHZ



3.3.4、AC Characteristics 2

($T_{amb}=-40^{\circ}C$ to $+125^{\circ}C$, $V_{SS}=0V$, unless otherwise specified.)

Parameter	Symbol	V _{DD}	Conditions	Min.	Typ.	Max.	Unit
propagation delay time	t _{PHL} , t _{PLH}	5V	CP to Qn See Figure 4	-	-	186	ns
		10V		-	-	78	ns
		15V		-	-	54	ns
MR to Qn HIGH to LOW propagation delay time	t _{PHL}	5V	See Figure 5	-	-	210	ns
		10V		-	-	84	ns
		15V		-	-	60	ns
transition time	t _{THL} , t _{TLH}	5V	See Figure 4	-	-	144	ns
		10V		-	-	72	ns
		15V		-	-	48	ns
set-up time	t _{su}	5V	See Figure 5	24	-	-	ns
		10V		12	-	-	ns
		15V		12	-	-	ns
hold time	t _{hold}	5V	See Figure 5	12	-	-	ns
		10V		6	-	-	ns
		15V		6	-	-	ns
Minimum clock pulse width;LOW	t _{WCPL}	5V	See Figure 5	84	-	-	ns
		10V		36	-	-	ns
		15V		24	-	-	ns
Minimum MR pulse width;LOW	t _{WMRL}	5V	See Figure 5	84	-	-	ns
		10V		45	-	-	ns
		15V		30	-	-	ns
Recovery time for MR	t _{RMR}	5V	See Figure 5	54	-	-	ns
		10V		24	-	-	ns
		15V		18	-	-	ns
Maximum clock pulse frequency	f _{max}	5V	-	4	-	-	MHZ
		10V	-	12	-	-	MHZ
		15V	-	16	-	-	MHZ



4、Testing Circuit

4.1、AC Testing Circuit

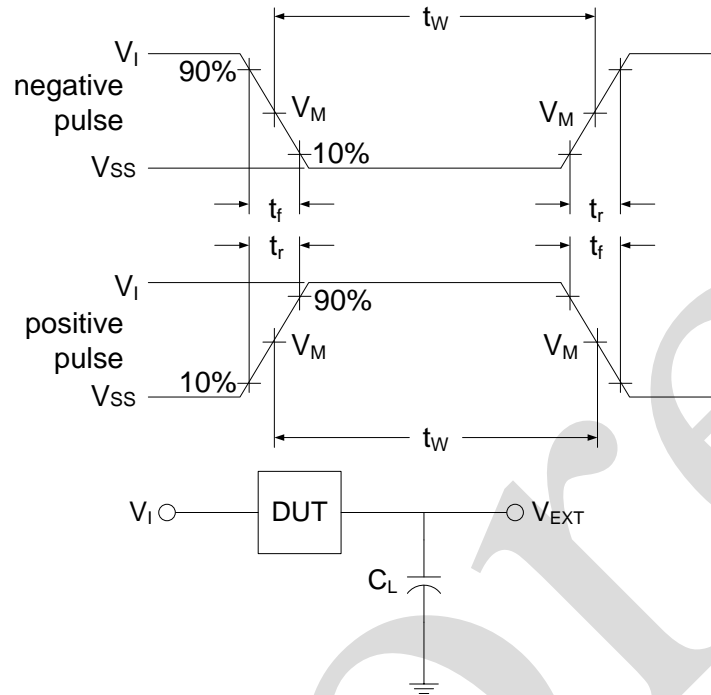


Figure 3. Load circuit

C_L includes probe and jig capacitance.

4.2、Test Data

Supply voltage	Input		Load	V_{EXT}		
V_{DD}	V_I	$t_r = t_f$	C_L	t_{PLH}/t_{PHL}	t_{PLZ}/t_{PZL}	t_{PHZ}/t_{PZH}
5V to 15V	V_{DD}	$\leq 20\text{ns}$	50pF	Open	V_{DD}	V_{SS}

4.3、AC Testing Waveforms

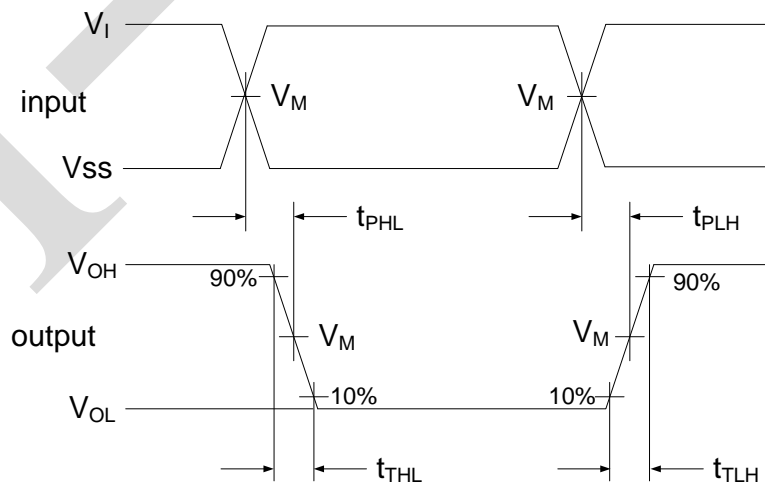


Figure 4. Propagation delay, output transition time

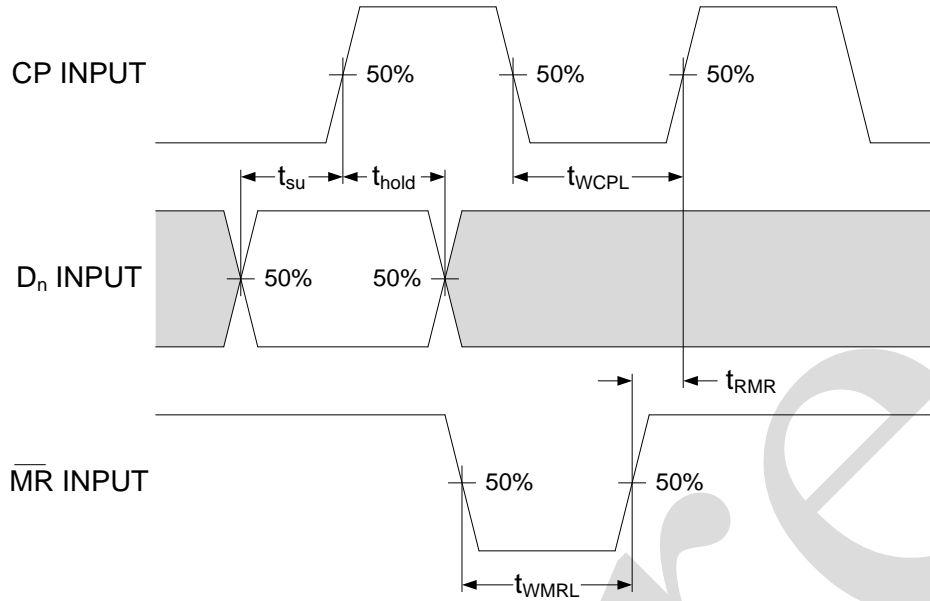


Figure 5. Waveforms showing minimum pulse widths for CP and $\overline{\text{MR}}$, $\overline{\text{MR}}$ to CP recovery time, and set-up time and hold time for Dn to CP. Set-up and hold times are shown as positive values but may be specified as negative values.

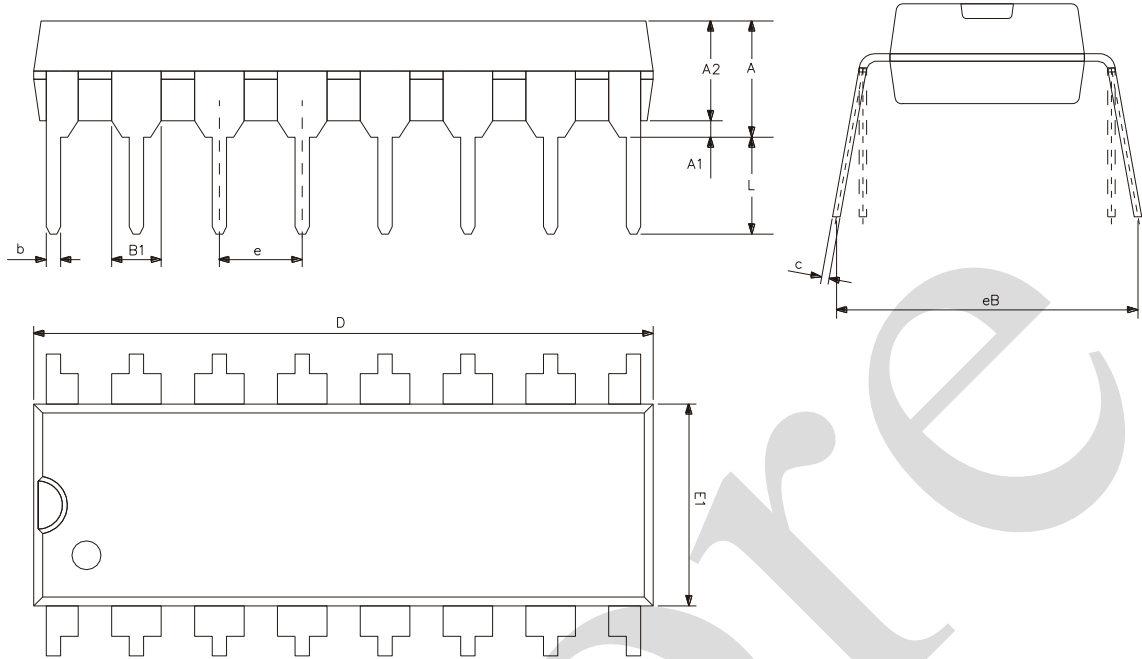
4.4. Measurement Points

Supply voltage	Input	Output		
V_{DD}	V_M	V_M	V_X	V_Y
5V to 15V	$0.5 \times V_{DD}$	$0.5 \times V_{DD}$	$0.1 \times V_{DD}$	$0.9 \times V_{DD}$



5、Package Information

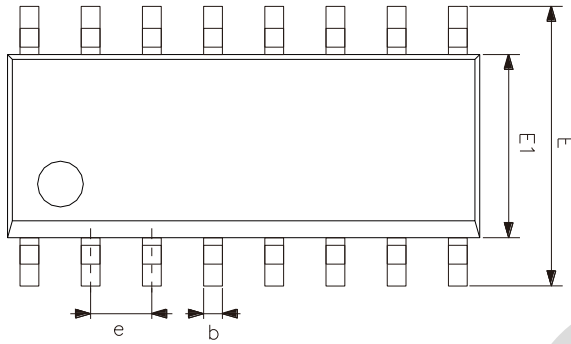
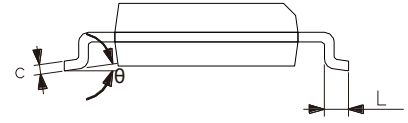
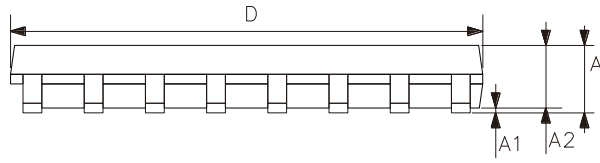
5.1、DIP16



Symbol	Dimensions (mm)	
	Min.	Max.
A2	3.20	3.60
A1	0.51	-
A	3.60	5.33
L	3.00	3.60
b	0.36	0.56
B1	1.52	
D	18.80	19.94
E1	6.20	6.60
e	2.54	
c	0.20	0.36
eB	7.62	9.30



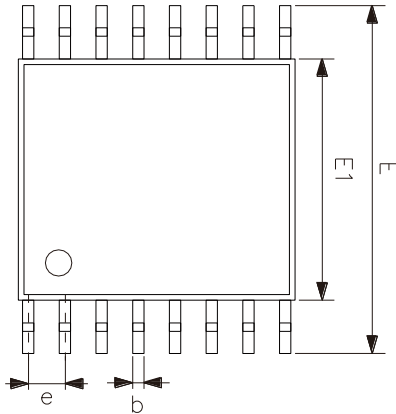
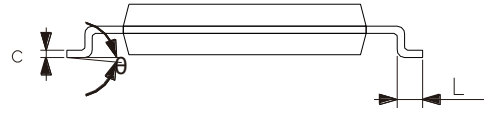
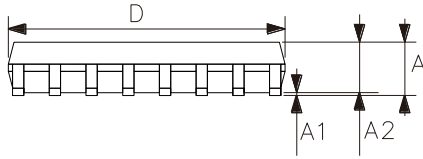
5.2、SOP16



Symbol	Dimensions (mm)	
	Min.	Max.
A	1.35	1.80
A1	0.10	0.25
A2	1.25	1.55
b	0.33	0.51
c	0.19	0.25
D	9.50	10.10
E	5.80	6.30
E1	3.70	4.10
e	1.27	
L	0.35	0.89
θ	0°	8°



5.3. TSSOP16



Symbol	Dimensions (mm)	
	Min.	Max.
A	-	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	4.90	5.10
E1	4.30	4.50
E	6.20	6.60
e	0.65	
L	0.45	0.75
θ	0°	8°



6、 Statements And Notes

6.1、 The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○: Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×: Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.									

6.2、 Notes

We Recommend you to read this chapter carefully before using this product.

The information in this chapter is provided for reference only and i-Core disclaims any express or implied warranties, including but not limited to applicability, special application or non-infringement of third party rights.

This product is not suitable for critical equipment such as life-saving, life-sustaining or safety equipment. It is also not suitable for applications that may result in personal injury, death, or serious property or environmental damage due to product malfunction or failure. I-Core will not be liable for any damages incurred by the customers at their own risk for such applications.

The customer is responsible for conducting all necessary tests i-Core's application to avoid failure in the application or the application of the customer's third party users. I-Core does not accept any liability.

The Company reserves the right to change or improve the information published in this chapter at any time.

The information in this chapter are subject to change without notice. We recommend the customer to consult our sales staff before purchasing.

Please obtain related materials form i-Core's regular channels and we are not responsible for its content if it is provided by sources other than our company.

In case of any conflict between the Chinese and English version, the version is subject to the Chinese one.